



Status of the HL-LHC LS2 radiation qualifications and LS3 radiation-tolerant designs

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8th HL-LHC Collaboration Meeting at CERN – 18/10/2018



Radiation Hardness Assurance for HL-LHC

Already covered in "Update of the expected radiation levels for HL-LHC", Giuseppe Lerner

Radiation Monitoring and Calculation

Rad-tol system development (mainly)

based on COTS

Radiation Hardness Assurance

Qualification Approach

Radiation Test Facilities

- Presentation outline:
 - Overview and Implementation of R2E Radiation Hardness Assurance
 - Status of LS2/LS3 HL-LHC radiation tolerant developments





Outline

- Overview and Implementation of R2E Radiation Hardness Assurance
- Status of LS2/LS3 HL-LHC radiation tolerant developments

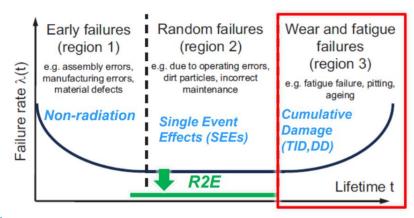


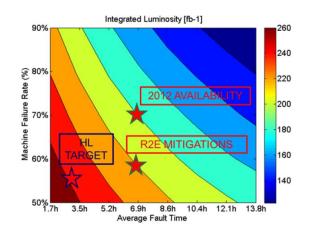


R2E status and future challenges/risks

- Presently (Run 2), R2E failures in the LHC remain in the shadow for operation (i.e. relatively small impact on availability & performance*)
- However [R2E Cost & Schedule Review 2017]:
 - R2E Lifetime failures are not constant in time (fluence) and could appear at a similar stage for many different distributed system units (e.g. nQPS, 60A converters...)
 - R2E SEE failures that are acceptable in terms of premature dumps (1-10 dumps/system/year) for present operation might not be acceptable for HL-LHC (tighter availability constraints, increased radiation levels)
 - The injector availability is critical for LHC operation; so far, no systematic R2E approach has been applied, and post-LIU operation will involve new equipment and different (typically more severe) radiation level distribution (e.g. SPS LSS5 dump area)

(*) LHC availability report, 2017

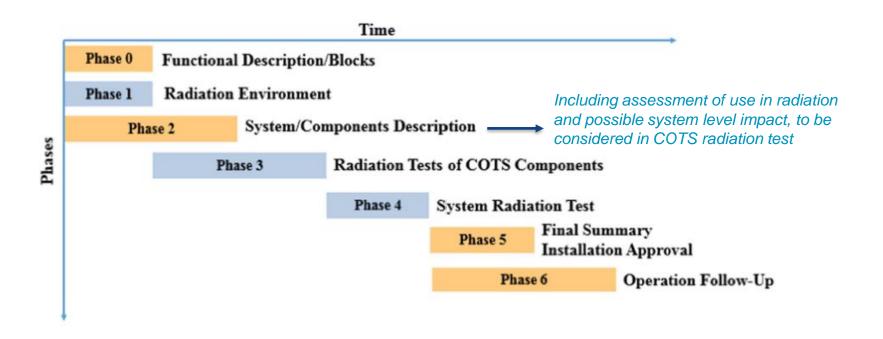








RHA guidelines for COTS-based systems



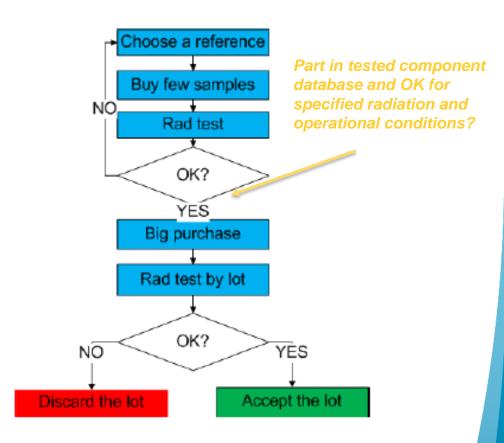
- Considering radiation tolerance constraints at very early (initial) stage of design
- Validation of radiation tolerance at system level before final production





Lot screening and acceptance

- Components purchased through vendors which obtain them from different foundries
- Dedicated production follow-up (i.e. full traceability) is expensive
- We rely on the assumption that COTS samples belong to same lot when they have same date code
- Common COTS
 procurement, storage and up-screening (electrical + radiation) strategy is crucial for on-going/future (e.g. LS3) developments







R2E RHA documents

- RHAPS: Process Structure → Pure RHA guideline which gives information about the process and guides the user through the design and qualification methodology
- RHAPV: Project Validation (new project) → report of the project information, radiation environment, radiation tests [linked to Engineering Change Request]
- RHACD: Check document (existing equipment) → report the cards changed and if they are conform with the RHAPS

New Developments

- Have to follow a radiation assurance procedure RHA
- The criticality needs to be assessed
- The system has to be tested in a representative radiation environment

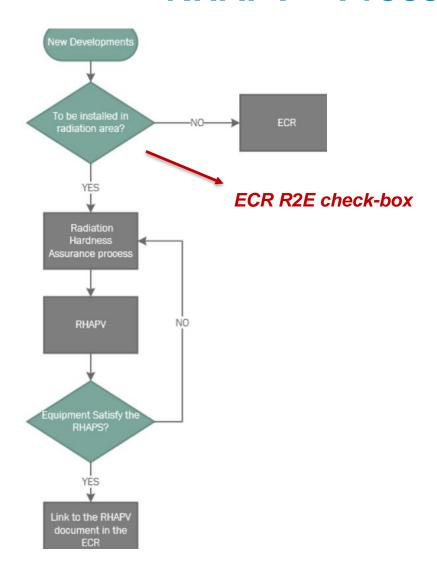
System already installed

- Their fault rate should be assessed
- The relocation should be notified
- The integration document will have a field pointing at the RHA document
- Any system change should be notified





RHAPV – Process Structure



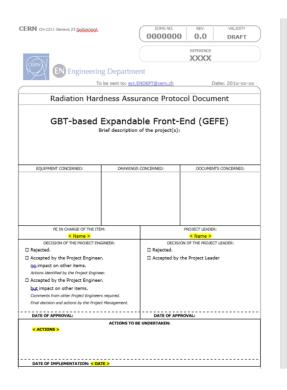
- Endorsed during 2017 R2E Cost & Schedule review
- Linked to LHC Engineering Change Request (ECR) as final validation
 - Check-box in ECR template for electronics installed in possible radiation areas
- Contains the RHA Project Validation document as cornerstone for equipment exposed to radiation
- RHAPV and ECR provide final validation, but actual R2E work starts at very early stage of system design

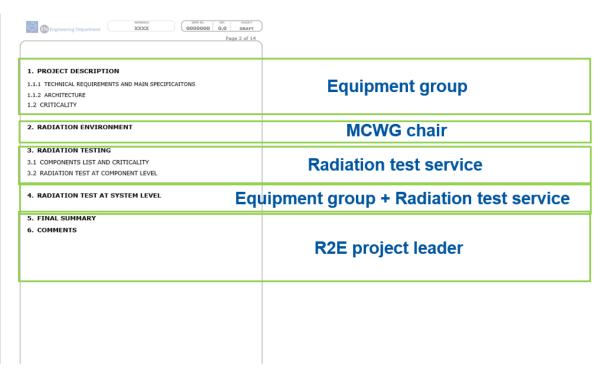




RHAPV – Project Validation

Example: GEFE BPM FE system





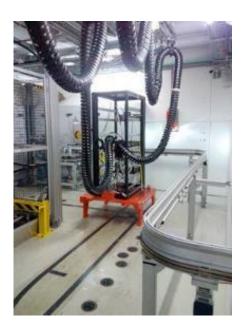
Document template available on EDMS (2028777)





CHARM R2E facility for system level testing

- Unique facility for radiation testing at component, board and system level in high-energy accelerator environment
- Facility makes use of available beam (PS East Area) while being specifically tailored for accelerator electronics qualification
- Similar approaches outside CERN at **board level**: neutron spallation (e.g. LANSCE, ChipIr), proton cyclotrons (e.g. PSI, KVI, TRIUMF), very-high energy heavy ions (GSI, NSRL)
- TID board/system level qualification possible also during LS2 in CERN cobalt-60 facility (CC60)











RHA LMC approval & recommendations

Summary of the 362nd LMC Meeting held on 26th September 2018

DECISION: the LMC endorses the proposal to formalize the Radiation Hardness Assurance (RHA) validation in the LHC.

RECOMMENDATION (for IEFC): the LMC recommends to follow the same RHA validation practices and formalization process in the LHC injectors.

ACTION (for EN-ACE and equipment groups): review the ECR template to include the R2E checkbox and update all ECRs for LS2 in order to ensure a good traceability.





Outline

- Overview and Implementation of R2E Radiation Hardness Assurance
- Status of LS2/LS3 HL-LHC radiation tolerant developments





R2E support & common building block activities

- MCWG (chair: Yacine Kadi)
 - In charge of radiation level calculation & monitoring
 - For calculations, strong link with Monte Carlo/FLUKA activities in EN/STI-BMI
 - Dedicated HL-LHC fellow: Giuseppe Lerner
- RADWG (chair: Salvatore Danzeca):
 - Support for rad-tol design and COTS component selection
 - Continuous radiation qualification of equipment group components at PSI
- R2E CERN facilities [CHARM, Cobalt-60] (WP leader: Salvatore Danzeca)
 - Facility operation, including dosimetry
 - Interface with users
 - Continuous upgrades (e.g. cryo-cooler integration in CHARM, cobalt-60 source activity increase)
- R2E external facilities for high-level TID testing (WP leader: Marco Calviani, activity technical responsible: Elisa Guillermain)
 - Mainly for passive TID testing (e.g. materials) up to MGy level
- R2E common building blocks (WP leaders: Salvatore Danzeca, Rubén García Alía)
 - In implementation: common purchase, screening, qualification & storage of COTS parts
 - FPGA-based modules: SmartFusion2, NanoExplore





R2M work-package in R2E

- Coordinating high-dose (~MGy) irradiation activities on electronics and (mainly) materials in external facilities (see table below)
- Key added value in optimizing resources by combining different users
- Examples of recent/on-going HL-LHC material irradiation campaigns:
 - Precision components for HL-LHC alignment systems [WP15.4]
 - Roller screws for adjustment of collimator jaws (TCPPM, TCSPM, TCLD...) [WP5]
 - Several irradiations for EP/DT HL-LHC detectors

Facility	Radiation	Min	Max	Active ?	Location
Fraunhofer TK100	Gamma	2 Gy/h	300 Gy/h	Yes	Germany
Fraunhofer TK1000	Gamma	1 Gy/h	10 kGy/h	Yes	Germany
BGS (Fraunhofer)	Gamma	700 Gy/h	30 kGy/h (70 kGy/h)	No	Germany
Ionisos	Gamma	20 Gy/h in static	2.5 kGy/h in conveyor	No (Powering possible)	Near Lyon









Overview of converters in HL-LHC radiation areas

Location	Converters		
ARC	376x LHC60A-08V 376x R2E-HL-LHC60A-10V		
RR13/17	36x R2E-HL-LHC120A-10V 28x R2E-LHC600A-10V 30x R2E-LHC4-6-8kA-08V		
RR53/57	36x R2E-HL-LHC120A-10V 28x R2E-LHC600A-10V 30x R2E-LHC4-6-8kA-08V		
RR73/77	20x R2E-HL-LHC120A-10V 48x R2E-LHC600A-10V 2x R2E-HL-LHC600A-10V (*)		

Operating in present LHC machine System radiation tolerance validated in CHARM; LS2 installation

Architecture/component selection; LS3 installation

(*) 11T trims, equipment code HCRPMBE

Note: possibility of having 200A converters (equipment code HCRPMBG) in UL14/16 if warm powering is moved from UR (same applies to 120A [HCRPLBC] which are already foreseen to be radiation tolerant

With input from Yves Thurel and Michele Martino





FGClite & 600A/4-6-8 kA

- Essential systems for HL-LHC availability & performance
- Followed the R2E development & qualification procedure, including CHARM system level validation
- Machine deployment:
 - FGClite:
 - EYETS 16-17 in LHC ARC (752 units), excellent availability in 2017 & 2018 runs
 - RRs 1/5/7: during LS2
 - 600A & 4/6/8 kA:
 - RRs 1/5/7: during LS2

System	TID	SEE XC [cm ²]	DD [cm ⁻²]
FGClite	>200	<10 ⁻¹³	>10 ¹²
600A & 4/6/8 kA	>70 (*)	<10 ⁻¹²	>10 ¹²

(*) including factor 3 safety margin for ELDRS









With input from Yves Thurel and Slawosz Uznanski





60A & 120A

- 120A:
 - Timeline: to be installed during LS3
 - Locations:
 - RR1/5/7
 - open option of relocating UR 200A and 120A converters to UL14, UL16, UL557 & UCS55
- 60A:
 - Timeline: to be installed during LS3
 - Baseline: production of ~half the 752 units as rad-tol, redundant
- Design considerations:
 - Based on 600A, 4Q design
 - 60A and 120A to be based on same basic unit [60A-10V power brick], with n+1 redundancy (2x 60A, 3x 120A)
- R2E considerations:
 - FGClite and 4/6/8 kA component references to be re-used whenever possible; batch acceptance of such parts to be carried out at part/system level in CHARM (Run 3)
 - New critical references to be tested at component level (LS2, start of Run 3)





LHC60A-08V

With input from Yves Thurel and Michele Martino





Bi-Volt/Tri-Volt PSU

- Aims at providing 1400 bi-volt [DCCT] and 1000 tri-volt [FGC] radiation tolerant units (*)
- Estimated radiation lifetime for presently installed units (mainly RRs): 25-50 Gy, as confirmed in CHARM tests (EDMS 1933100)
 - Limiting factor: DCDC converter module
- R2E project for development & qualification of radiation tolerant bi-volt/tri-volt PSU
 - Critical element: DCDC converter; main action paths:
 - Test of commercially available DCDC converter modules** (RADWG, Salvatore Danzeca)
 - Collaboration with industry for COTS selection (e.g. power MOSFET, optocoupler) in existing DCDC design
 - In-house COTS DCDC converter design



600A fan tray: possible need of rad-tol design, as opposed to initially expected

(*) final number of units will depend on HL-LHC 60A architecture and possible need of separate FGClite power supply (**) for COTS modules, Bill-Of-Material and traceability of COTS components is essential to mitigate radiation failure risk

With input from Slawosz Uznanski and Ben Todd





11T uQDS

- QDS function defined by FPGA configuration (Microsemi IGLOO2)
- ADC: 20bits/1Msps
- Quench heaters located as close as possible to magnet, monitoring in RR area (~75m away from magnet)
- Radiation tolerant up to RR73/RR77 environment
- CHARM 2018 test: one week
- Further component tests foreseen at PSI (ADC, DC-DC...)



"Status of Hardware for quench detection and circuit monitoring for HL-LHC", Jens Steckert, 7th HiLumi Collaboration Meeting, Madrid, 13-16 Nov. 2017



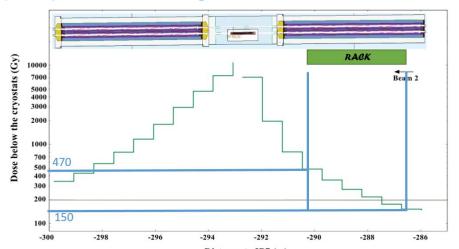


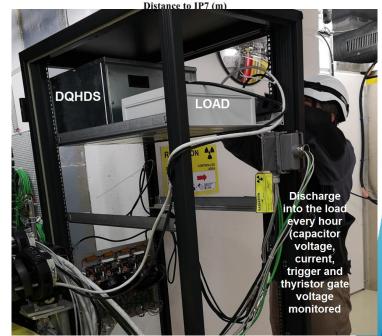


MPE-EE 11T quench heater power supply (DQHDS)

- Partial side of the rack will be exposed to a radiation up to 400-500 Gy
- Component level tests in PSI up to 500 Gy
 - Optocouplers to replace triggering relay (will not be used in the end) (EDMS reports: 2002397, 2002401, 2002403)
 - Regulator/transistors (EDMS reports: 2011367, 2029282)
 - Thyristors to be tested
- System level test in CHARM up to 500 Gy
 - Two DQHDS units tested had detectable failure at ~420 Gy and ~470 Gy
 - "Safe" failure mode, as it is detectable before quench
 - Cause of failure under investigation
- A strategy of replacement or exchange might be put in place during HL-LHC

With input from David Carrillo and Jelena Spasic









Cold by-pass diode

- WP10 definition of HL-LHC radiation levels for:
 - Cold diodes presently installed in the machine
 - Cold diodes to be possibly installed in IP1
 & IP5 inner triplet (DFX location)
- Integration of cryo-cooler setup in CHARM facility
- Related dosimetry during tests
 - Expected radiation levels for full CHARM run at cryo-cooler of ~10 kGy and ~2×10¹⁴ n/cm²
- Evaluation of possible further tests (pure gamma field, CHARM during Run 3...)
- Dedicated presentations during 2018 HL-LHC week



"Update on Cold Diodes Project for HL-LHC", Giorgio D'Angelo HL-LHC TCC #55, August 2018

With input from Giorgio D'Angelo





Temperature controller + solidstate relay (current leads)

- Installed in RRs of IP1, 5 & 7 (364 controllers in total)
- Temperature controllers tested in CHARM in 2018:
 - Failure due to power board (potentially linked to power MOSFET SEB)
 - Failure rate acceptable for Run 3, radiation reliability to be improved for HL-LHC
- COTS system:
 - Importance of access to schematics and bill-of-material (BOM)
 - Traceability of references/lots is crucial

With input from Giorgio D'Angelo











Radiation-tolerant conditioning electronics for pressure sensors

- To be installed in DS (LS2) and ARC (LS3)
- Upgrade from present system: 4-20mA transmission (as opposed to 0-10V) resulting in reduced signal loss and noise coupling
- Radiation qualification:
 - At component level: 18 COTS references tested at PSI up to 500Gy, 15 accepted → batch procurement of accepted parts
 - At system level: in CHARM, two weeks of irradiation for each subsystem

With input from Nikolaos Chatzigeorgiou and Gregory Pigny







LHC BPM system

- Complete consolidation: 1100 devices, aiming at LS3 (LS4 possible, but components would need to be ready after LS3 as back-up)
 - R2E sub-activity: rad-hard optical transceiver for mono-mode fiber transmission

LHC-CONS, with HL-LHC radiation level & availability requirements



LHC BLM system

- Surface electronics by LS3, tunnel electronics by LS4
- Aiming at same system as SPS ring BLM (reusing LpGBTx and VTRx+)

With input from Thibaut Lefevre and Rhodri Jones



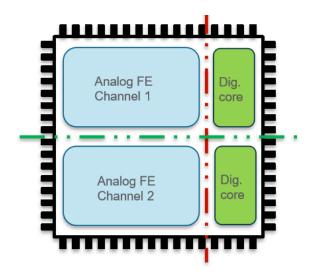


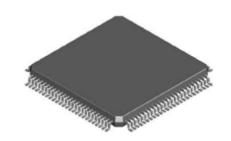
Rad-hard FE for LHC BLM in IP1, 3, 5 and 7

- Development of radiation hard ASIC BLM to increase margin between quench threshold & noise level
- Target radiation tolerance: 1 MGy
 - 2018: design & production
 - 2019: radiation testing

Other R&D activities

- HL-LHC BE/BI activities (LS3):
 - LHC new luminosity detectors
 - Beam-gas vertex detectors
- Rad-Hard camera to replace vidicon tube (LS3):
 - Option 1: rad-hard CMOS development
 - Option 2: optical fibre bundle to move imaging sensor to radiation safe area





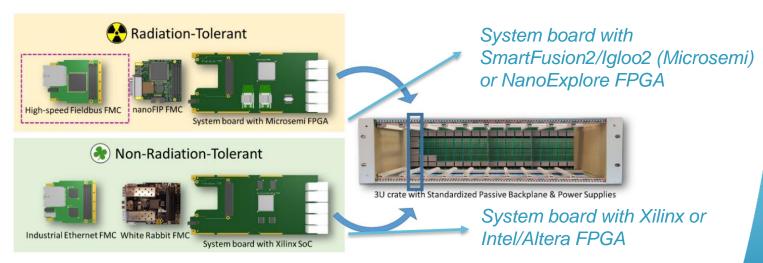
With input from Thibaut Lefevre, Rhodri Jones and Luca Giangrande





Distributed I/O Tier project

- Development of generic radiation-tolerant power supply for distributed I/O Tier project
 - Architecture design and part/module selection (critical building block: DCDC converter)
- Radiation tolerant high-speed fieldbus slave (industrial Ethernet protocol **POWERLINK**)
 - 2018 tests in CHARM (runs & analysis on-going):
 - running on hard ARM core of SmartFusion2
 - RISC-V soft-core (TRM protected) with ECC ram







With input from Javier Serrano and Mattia Rizzi

Conclusions & Outlook

- Formalization of Radiation Hardness Assurance procedure will contribute to increase
 R2E quality assurance for accelerator equipment
 - Implemented as ECR check, but this is only the final step (i.e. R2E constraints to be considered at initial project stage)
 - Main HL-LHC challenges:
 - Radiation lifetime issues in (installed) distributed equipment, not visible now but which could impact many systems at similar time
 - SEEs in sensitive equipment in areas with enhanced radiation levels e.g. PLCs in ULs)
 - R2E reliably in injector chain (enhanced radiation levels, LIU equipment)
- Status of LS2 radiation tolerant equipment:
 - Radiation qualification completed at system level (CHARM) for critical distributed equipment
 - Formalization of followed RHA procedure in dedicated document, to be linked to ECRs
- Status of LS3 radiation tolerant developments:
 - System architecture design, considering radiation environment constraints
 - Identification & qualification of critical components
 - Importance of common component qualification & purchase
 - Common module/sub-system developments (power units, analogue signal conversion & processing, etc.)





HL-LHC 2018 annual meeting references

- **[WP13]** "Status of the beam gas vertex profile monitor development for HL-LHC", Robert Kieffer (Tuesday PM)
- **[WP7]** "Impact of HL-LHC radiation levels on cold diodes and first results from radiation tests" Giorgio D'Angelo (Wednesday plenary session)
- **[WP10]** "Update of the expected radiation levels for HL-LHC", Giuseppe Lerner (Wednesday AM)
- **[WP7]** "Long term strategy for LHC DS cold diodes", Giorgio D'Angelo (Wednesday AM)
- **[WP7]** "Diode radiation tests, setup and first results", Arnaud Monteuuis (Wednesday AM)
- **[WP13]** "Status of luminosity monitor design for HL-LHC", Marcus Palm (Wednesday AM)
- **[WP13]** "Design options for the BLM ASIC", Luca Giangrande (Wednesday AM)
- **[WP7]** "Status of detection electronics for 11T protection including trim protection", Jens Steckert (Wednesday PM)
- [WP7] "11T protection racks", David Carrillo (Wednesday PM)
- [WP7] "HL-LHC operation impacting existing LHC protection systems", Reiner Denz (Thursday PM)
- **[WP7]** "Results of radiation tests with HL-LHC detection electronics and quench heater power supplies", Jelena Spasic (Thursday PM)
- **[WP13]** "Measuring beam size with the BGV results from the demonstrator in run 2", Benedikt Wurkner (Thursday PM)
- **[WP13]** "Specifications for the HL-LHC BPM system", Manfred Wendt (Thursday PM)



